| Column 1 Tariff Item Number | Column 2 Description of Goods | Column 3 Base Rate | Column 4 Category | Column 5 Note |
|---|---|---|---|---|
| 8483.90.91.00.00 | - - - For goods of subheading 8701.10 or 8701.90 | 10% | B10 | |
| 8483.90.93.00.00 | - - - For other tractors of heading 87.01 | 10% | B10 | |
| 8483.90.94.00.00 | - - - For goods of heading 87.11 | 10% | B10 | |
| 8483.90.95.00.00 | - - - For other goods of Chapter 87 | 5% | B8 | |
| 8483.90.99.00.00 | - - - Other | 10% | B10 | |
| 84.84 | Gaskets and similar joints of metal sheeting combined with other material or of two or more layers of metal; sets or assortments of gaskets and similar joints, dissimilar in composition, put up in pouches, envelopes or similar packings; mechanical seals. | | | |
| 8484.10.00.00.00 | - Gaskets and similar joints of metal sheeting combined with other material or of two or more layers of metal | 3% | B8 | |
| 8484.20.00.00.00 | - Mechanical seals | 3% | B10 | |
| 8484.90.00.00.00 | - Other | 3% | B7 | |
| 84.86 | Machines and apparatus of a kind used solely or principally for the manufacture of semiconductor boules or wafers, semiconductor devices, electronic integrated circuits or flat panel displays; machines and apparatus specified in Note 9 (C) to this Chapter; parts and accessories. | | | |
| 8486.10 | - Machines and apparatus for the manufacture of boules or wafers: | | | |
| 8486.10.10.00.00 | - - Apparatus for rapid heating of semiconductor wafers | | A | |
| 8486.10.20.00.00 | - - Spin dryers for semiconductor wafer processing | 5% | B2 | |
| 8486.10.30.00.00 | - - Machines for working any material by removal of material, by laser or other light or photon beam in the production of semiconductor wafers | | A | |
| 8486.10.40.00.00 | - - Machines and apparatus for sawing monocrystal semiconductor boules into slices, or wafers into chips | | A | |
| 8486.10.50.00.00 | - - Grinding, polishing and lapping machines for processing of semiconductor wafers | | A | |
| 8486.10.60.00.00 | - - Apparatus for growing or pulling monocrystal semiconductor boule | | A | |
| 8486.10.90.00.00 | - - Other | | A | |
| 8486.20 | - Machines and apparatus for the manufacture of semiconductor devices or of electronic integrated circuits: | | | |

| Column 1 Tariff Item Number | Column 2 Description of Goods | Column 3 Base Rate | Column 4 Category | Column 5 Note |
|---|---|---|---|---|
| 8486.20.11.00.00 | - - Film formation equipment: | | | |
| | - - - Chemical vapor deposition apparatus for semiconductor production | | A | |
| 8486.20.12.00.00 | - - - Epitaxial deposition machines for semiconductor wafers; spinners for coating photographic emulsions on semiconductor wafers | | A | |
| 8486.20.13.00.00 | - - - Apparatus for physical deposition by sputtering on semiconductor wafers; physical deposition apparatus for semiconductor production | | A | |
| 8486.20.19.00.00 | - - - Other | | A | |
| | - - Doping equipment: | | | |
| 8486.20.21.00.00 | - - - Ion implanters for doping semiconductor materials | | A | |
| 8486.20.29.00.00 | - - Other | | A | |
| | - - Etching and equipment: | | | |
| 8486.20.31.00.00 | - - - Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process; spraying appliances for etching, stripping or cleaning semiconductor wafers | | A | |
| 8486.20.32.00.00 | - - - Equipment for dry-etching patterns on semiconductor materials | | A | |
| 8486.20.33.00.00 | - - - Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers | | A | |
| 8486.20.39.00.00 | - - - Other | | A | |
| | - - Lithography equipment: | | | |
| 8486.20.41.00.00 | - - - Direct write-on-wafer apparatus | 5% | B2 | |
| 8486.20.42.00.00 | - - - Step and repeat aligners | 5% | B2 | |
| 8486.20.49.00.00 | - - - Other | | A | |
| | - - Equipment for developing exposed wafers: | | | |
| 8486.20.51.00.00 | - - - Dicing machines for scribing or scoring semiconductor wafers | | A | |
| 8486.20.59.00.00 | - - - Other | | A | |
| | - - Other: | | | |
| 8486.20.91.00.00 | - - - Lasercutters for cutting contacting tracks in semiconductor production by laser beam | | A | |
| 8486.20.92.00.00 | - - - Machines for bending, folding and straightening semiconductor leads | | A | |
| 8486.20.93.00.00 | - - - Resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers | | A | |